

**DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION**

(Joint Inventors)

We as the below named inventors, declare that:

Our residences, post office addresses and citizenships are as stated below next to our names.

We believe we are the original, first and joint inventors of the subject matter which is claimed and for which patent is sought on the invention entitled:

**MULTI-DICE CHIP SCALE SEMICONDUCTOR COMPONENTS
AND WAFER LEVEL METHODS OF FABRICATION**

the specification of which (check one)

☒ is attached hereto.

☐ was filed Application Serial No. _____
and was amended on (if applicable) _____.

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Sec. 1.56(a).

We hereby claim foreign priority under Title 35, United States Code, Sec. 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: NONE

We hereby claim the benefit under Title 35, United States Code, Sec. 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 11, we acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Sec. 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application: NONE

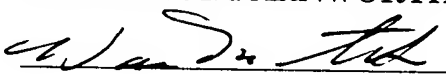
POWER OF ATTORNEY: We hereby appoint as our attorneys, Stephen A. Gratton, Reg. No. 28,418; Michael L. Lynch, Reg. No. 30,871; Charles B. Brantley, II, Reg. No. 38,086; Kevin D. Martin, Reg. No. 37,882; and David J. Paul, Reg. No. 34,692, with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. All correspondence and telephonic communications should be directed to:

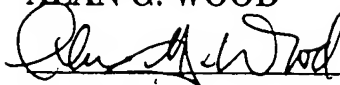
STEPHEN A. GRATTON
2764 South Braun Way
Lakewood, CO 80228


Telephone: (303) 989 6353
Fax: (303) 989 6538

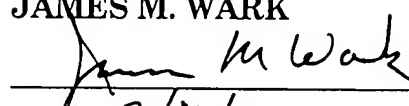
We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and such willful false statements may jeopardize the validity of the application or any patent issued thereon.

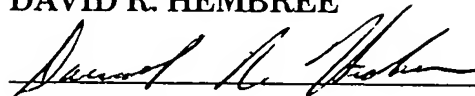
Wherefore, we pray that Letters Patent be granted to us for the invention or discovery described and claimed in the foregoing specification and claims, declaration, power of attorney, and this petition.

INVENTOR'S FULL NAME:	WARREN M. FARNWORTH
INVENTOR'S SIGNATURE:	<u></u>
DATE OF SIGNATURE:	<u>03/05/03</u>
RESIDENCE (CITY AND STATE):	Nampa, Idaho
CITIZENSHIP (COUNTRY):	United States of America
POST OFFICE ADDRESS:	2004 S. Banner Nampa, ID 83686

INVENTOR'S FULL NAME: **ALAN G. WOOD**
INVENTOR'S SIGNATURE: 
DATE OF SIGNATURE: 3/7/03
RESIDENCE (CITY AND STATE): Boise, Idaho
CITIZENSHIP (COUNTRY): United States of America
POST OFFICE ADDRESS: 1366 E. Versailles Court
Boise, ID 83706

INVENTOR'S FULL NAME: **WILLIAM M. HIATT**
INVENTOR'S SIGNATURE: 
DATE OF SIGNATURE: 03.05.03
RESIDENCE (CITY AND STATE): Eagle, Idaho
CITIZENSHIP (COUNTRY): United States of America
POST OFFICE ADDRESS: 1137 West Stafford Drive
Eagle, ID 83616

INVENTOR'S FULL NAME: **JAMES M. WARK**
INVENTOR'S SIGNATURE: 
DATE OF SIGNATURE: 3/06/03
RESIDENCE (CITY AND STATE): Boise, Idaho
CITIZENSHIP: United States of America
POST OFFICE ADDRESS: 4119 W. Quail Ridge Drive
Boise, ID 83703

INVENTOR'S FULL NAME: **DAVID R. HEMBREE**
INVENTOR'S SIGNATURE: 
DATE OF SIGNATURE: 3/6/03
RESIDENCE (CITY AND STATE) Boise, Idaho
CITIZENSHIP: United States of America
POST OFFICE ADDRESS: 10855 Smoke Ranch Drive
Boise, ID 83709

INVENTOR'S FULL NAME:

KYLE K. KIRBY

INVENTOR'S SIGNATURE:

Kyle K. Kirby

DATE OF SIGNATURE:

3/5/03

RESIDENCE (CITY AND STATE)

Boise, Idaho

CITIZENSHIP:

United States of America

POST OFFICE ADDRESS:

10681 N. Sagecrest Pl.
Boise, ID 83703

INVENTOR'S FULL NAME:

PETE A. BENSON

INVENTOR'S SIGNATURE:

Pete A. Benson

DATE OF SIGNATURE:

3/5/03

RESIDENCE (CITY AND STATE)

Boise, Idaho

CITIZENSHIP:

United States of America

POST OFFICE ADDRESS:

5122 Surprise Street
Boise, ID 83716

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
WARREN M. FARNWORTH
ALAN G. WOOD
WILLIAM M. HIATT
JAMES M. WARK
DAVID R. HEMBREE
KYLE E. KIRBY
PETE A. BENSON

Serial No.:

Filing Date:

Title: MULTI-DICE CHIP SCALE SEMICONDUCTOR COMPONENTS
AND WAFER LEVEL METHODS OF FABRICATION

Docket No. 02-1500

ELECTION UNDER 37 C.F.R. §§3.71 AND 3.73 AND POWER OF ATTORNEY

Assistant Commissioner for Patents
Washington, DC 20231

Dear Sir:

The undersigned, being Assignee of the entire interest in the above-identified application by virtue of an Assignment recorded in the United States Patent and Trademark Office as set forth below or filed herewith, hereby elects, under 37 C.F.R. §3.71, to prosecute the application to the exclusion of the inventor(s).

The Assignee hereby revokes any previous Powers of Attorney and appoints: Stephen A. Gratton, Reg. No. 28,418; Michael L. Lynch, Reg. No. 30,871; Charles B. Brantley, II, Reg. No. 38,086; Kevin D. Martin, Reg. No. 37,882; and David J. Paul, Reg. No. 34,692, as its attorney or agent, with full power of substitution and revocation, to prosecute the application, to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, to receive any Letters Patent, and for one year after issuance of such Letters Patent to file any request for a certificate of correction that may be deemed appropriate.

Pursuant to 37 C.F.R. §3.73, the undersigned duly authorized designee of Assignee certifies that the evidentiary documents have been reviewed, specifically the Assignment to MICRON TECHNOLOGY, INC., referenced below, and certifies that to the best of my knowledge and belief, title remains in the name of the Assignee.

Assignment:

☒ Filed concurrently herewith for recording, a copy of which is attached hereto.

☐ Previously recorded on _____
at Reel/Frame _____

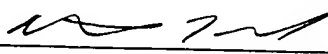
Please direct all communication as follows:

Stephen A. Gratton
THE LAW OFFICE OF STEPHEN A. GRATTON
2764 South Braun Way
Lakewood, CO 80228
(303) 989 6353

ASSIGNEE: MICRON TECHNOLOGY, INC.

Date: 3-25-03

By:


Michael L. Lynch, Chief Patent Counsel

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

WARREN M. FARNWORTH
ALAN G. WOOD
WILLIAM M. HIATT
JAMES M. WARK
DAVID R. HEMBREE
KYLE K. KIRBY
PETE A. BENSON

Serial No.:

Filing Date: Concurrently Herewith

Title: MULTI-DICE CHIP SCALE SEMICONDUCTOR COMPONENTS
AND WAFER LEVEL METHODS OF FABRICATION

Docket No. 02-1500

ASSIGNMENT:

☒ Enclosed for recording
☐ Previously recorded

Date: _____

Reel: _____

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency, and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN, AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which will be executed by the undersigned and is entitled: **MULTI-DICE CHIP SCALE SEMICONDUCTOR COMPONENTS AND WAFER LEVEL METHODS OF FABRICATION**; such application and all divisional, continuing, substitute, renewal, reissue, and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any

convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST, the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney, and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining, and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives, and successors of the undersigned and extend to the successors, assigns, and nominees of the Assignee.

(Signature)

Warren M. Farnworth
WARREN M. FARNWORTH

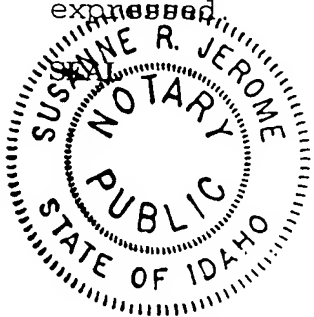
Date 03/05/03

STATE OF IDAHO

Iss.

COUNTY OF ADA

BEFORE ME, this 5th day of March, 2003, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.



Suzanne R. Jerome
Notary or Consular Officer of the
United States of America

My Commission Expires: 3/12/08

(Signature)

Alan G. Wood
ALAN G. WOOD

Date 3/7/03

STATE OF IDAHO

Iss.

COUNTY OF ADA

BEFORE ME, this 7th day of March, 2003, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.

SEAL

Suzanne R. Jerome
Notary or Consular Officer of the
United States of America

My Commission Expires: 3/12/08

(Signature)

William M. Hiatt
WILLIAM M. HIATT

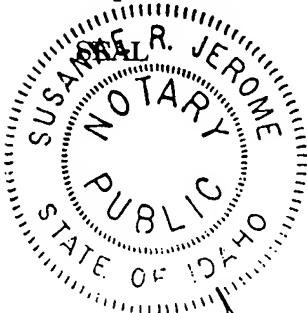
Date 03.05.03

STATE OF IDAHO

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COUNTY OF ADA

BEFORE ME, this 5th day of March, 2003, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.



Susanne R. Jerome
Notary or Consular Officer of the
United States of America

My Commission Expires: 3/12/08

(Signature)

James M. Wark
JAMES M. WARK

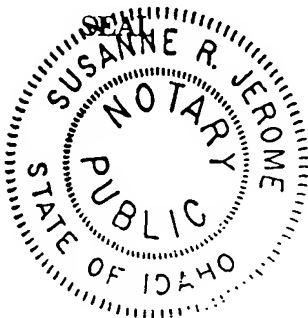
Date 3/6/03

STATE OF IDAHO

ss.

COUNTY OF ADA

BEFORE ME, this 6th day of March, 2003, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.



Susanne R. Jerome
Notary or Consular Officer of the
United States of America

My Commission Expires: 3/12/08

(Signature)

David R. Hembree
DAVID R. HEMBREE

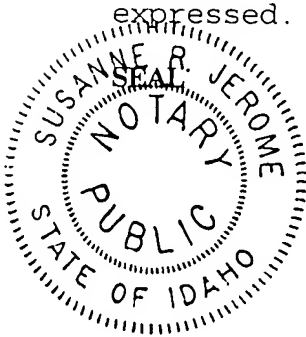
Date 3/6/03

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Susanne R. Jerome
Notary or Consular Officer of the
United States of America

My Commission Expires: 3/12/08

(Signature)

Kyle K. Kirby
KYLE K. KIRBY
K. KK

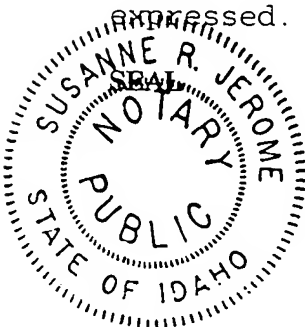
Date 3/5/03

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Susanne R. Jerome
Notary or Consular Officer of the
United States of America

My Commission Expires: 3/12/08

(Signature) Pete A. Benson
PETE A. BENSON

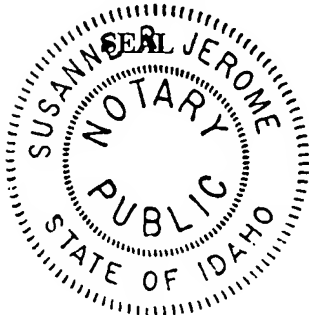
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My Commission Expires: 3/12/08